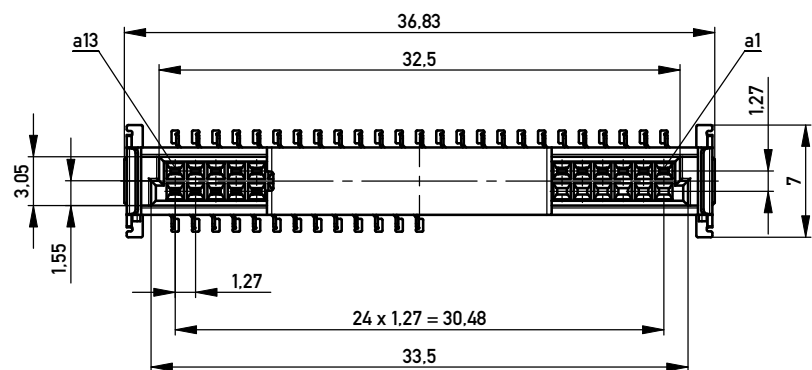
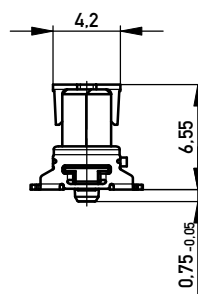
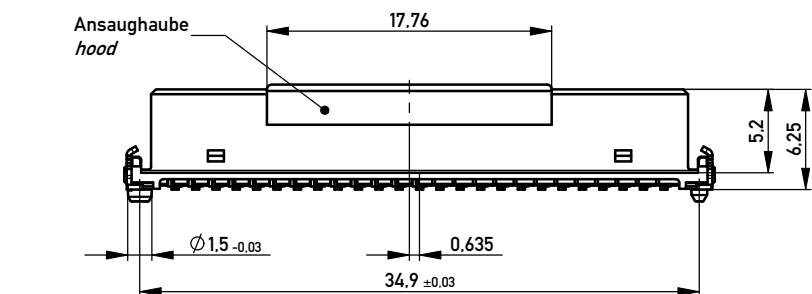
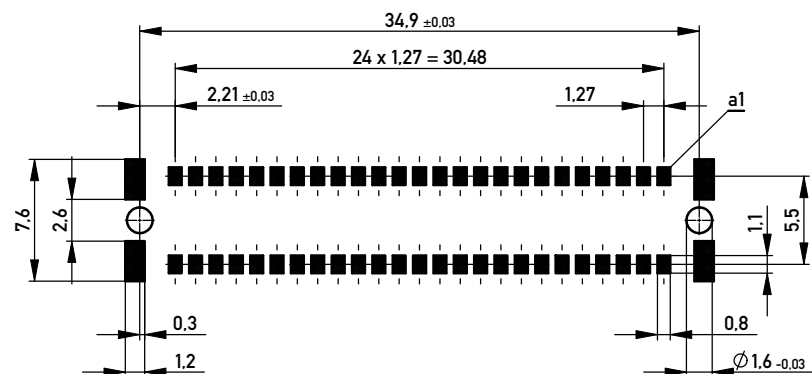


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



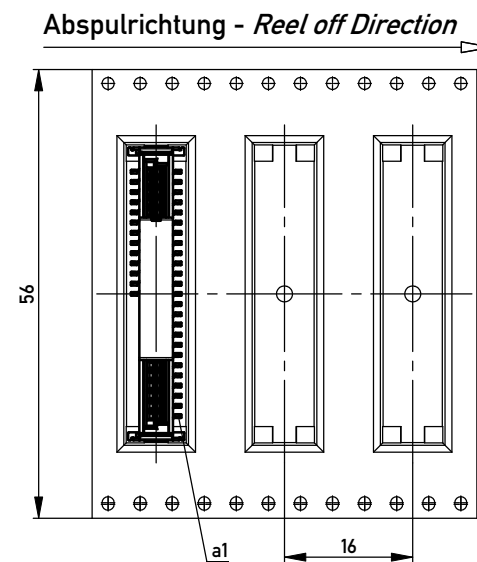
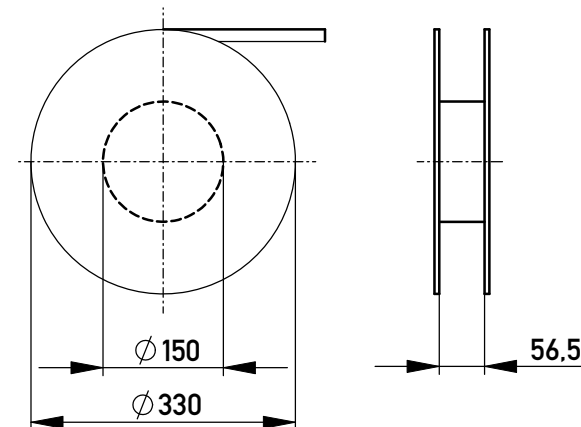
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

Verpackt in Gurtverpackung - Tape on Reel Packaging
Verpackungseinheit: 280 Stück - Packaging unit: 280 pcs



BA 7-13 - 8mm Bauhöhe
type7-13 - Low Profile

Information:		Tolerances		Scale 3:1	Designation	
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d	07.10.2010	 www.ERNI.com		154807		I
Index	Date	Class		SMCB		A3

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